SEOUL SEMICONDUCTOR

Specification

LR340

SSC		Customer
Drawn	Approval	Approval

Rev. 00

December 2007

www.ZLED.com

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Description

Lamp LEDs are effective in hot thermal and humid condition. This high brightness and weather-resistant packaging design makes these Lamp LEDs ideal for Outdoor applications such as traffic signals, variable message signs and backlighting for transparent sign panels.



LR340

Features

- **High luminous emission**
- **Non-standoff leads**
- **3mm type package**
- **Transparent epoxy lens**
- **Viewing angle : 44 º**
- **Dominant Wavelength : 641nm**

Applications

- Electronic signs and signals
- Specialty lighting
- Small area illumination
- Torches and head lamps
- Backlighting
- Outdoor displays

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2. Absolute Maximum Ratings (T_a = 25ºC)

Item	Symbol	Value	Unit
DC Forward Current	I_F	30	mA
Forward Peak Pulse Current	I_{FP} [1]	100	mA
Reverse Voltage	V_R	5	V
Power Dissipation	P_D	69	mW
Operating Temperature	T_{opr}	-40 ~ 100	ºC
Storage Temperature	T_{stg}	-50 ~ 105	ºC
Solder Temperature	T_s	260ºC for 10seconds [2]	ºC

Notes :
[1] $t \leq 0.1$ms, D = 1/10
[2] No lower than 3mm from the base of the epoxy bulb.

3. Electro-Optical Characteristics (T_a = 25ºC, I_F=20mA)

Item	Symbol	Value			Unit
		Min.	Typ.	Max.	
Luminous Intensity [3]	I_V [4]	200	450	-	mcd
Dominant Wavelength[5]	λ_d		641		nm
Forward Voltage [6]	V_F	-	1.8	2.3	V
View Angle	$2\theta_{1/2}$		44		deg.
Reverse Current (at V_R = 5V)	I_R	-	-	5	μA

Notes :
[3] SSC maintains a tolerance of ±10% on intensity and power measurements.
[4] I_V is the luminous intensity output as measured with a cylinder.
[5] Dominant wavelength is derived from the CIE 1931 Chromaticity diagram.
A tolerance of ±0.5nm for dominant wavelength.
[6] A tolerance of ±0.05V on forward voltage measurements

4. Reliability Tests

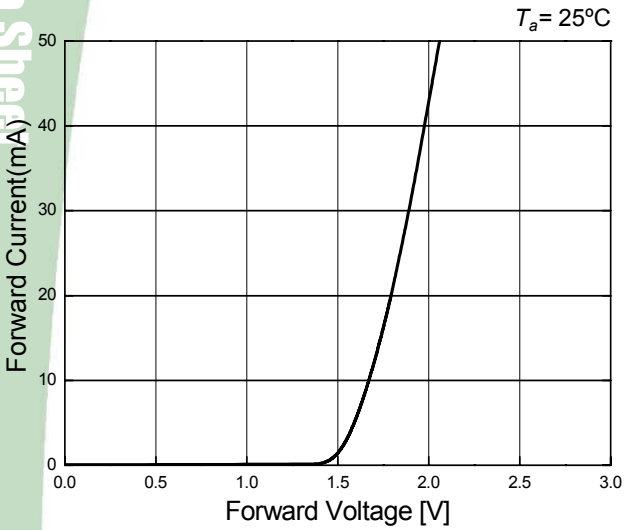
Item	Condition	Note	Failures
Life Test	T_a = RT, I_F = 30mA	1000hrs	0/22
High Temperature Operating	T_a = 100ºC, I_F = 10mA	1000hrs	0/22
Low Temperature Operating	T_a = -40ºC, I_F = 20mA	1000hrs	0/22
Thermal Shock	T_a = -50ºC (30min) ~ 105º (30min) (Transfer time : 10sec, 1Cycle = 1hr)	100 cycles	0/40
Resistance to soldering Heat	T_s = 255 ± 5ºC, t = 10sec	1 time	0/22
ESD (Human Body Model)	1kV, 1.5kΩ ; 100pF	1 time	0/22
High Temperature Storage	T_a = 105ºC	1000hrs	0/22
Low Temperature Storage	T_a = -50ºC	1000hrs	0/22
Temperature Humidity Storage	T_a = 85ºC, RH = 85%	1000hrs	0/22
Temperature Humidity Operating	T_a = 85ºC, RH = 85%, I_F = 15mA	100hrs	0/22

< Judging Criteria For Reliability Tests >

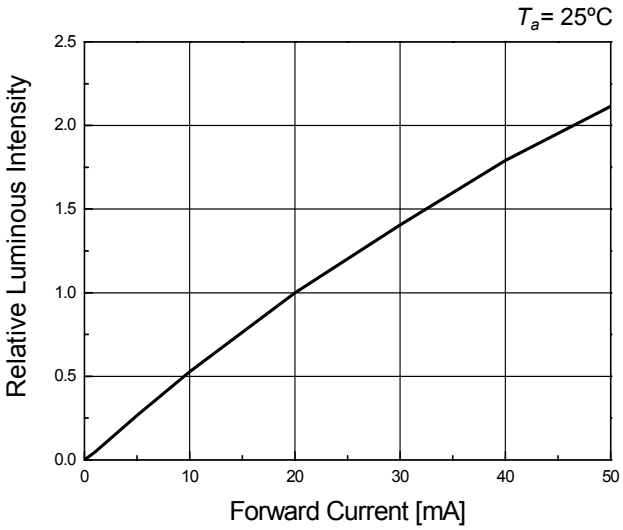
V_F	USL[1] X 1.2
I_R	USL X 2.0
Φ_V	LSL [2] X 0.7

Notes :
[1] USL : Upper Standard Level
[2] LSL : Lower Standard Level.

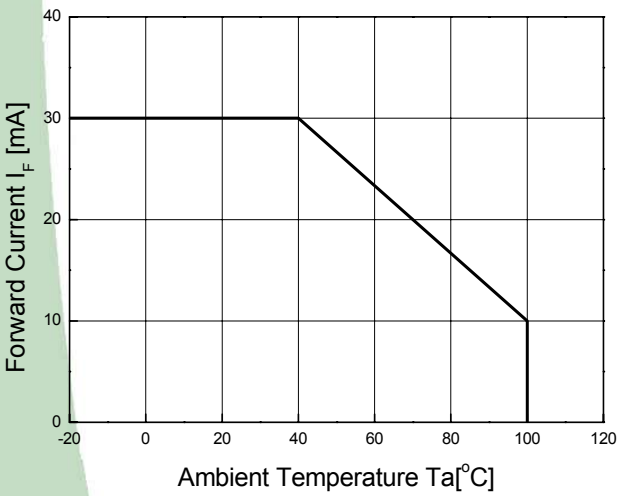
5. Characteristic Diagrams



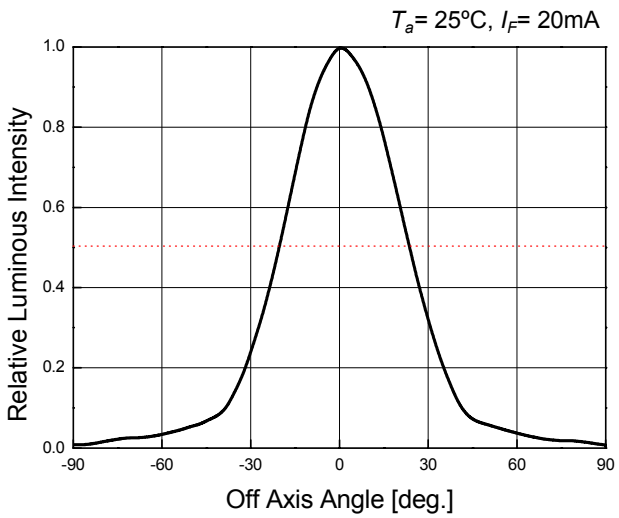
Forward Voltage vs. Forward Current



Forward Current vs. Relative Intensity



Ambient Temperature vs. Maximum Forward Current



Directivity

6. Color & Binning

Bin Code		
Luminous Intensity	Dominant Wavelength	Forward Voltage
A	-	-

Luminous Intensity (mcd) @ I_F = 20mA		
Bin Code	Min.	Max.
A	200	-

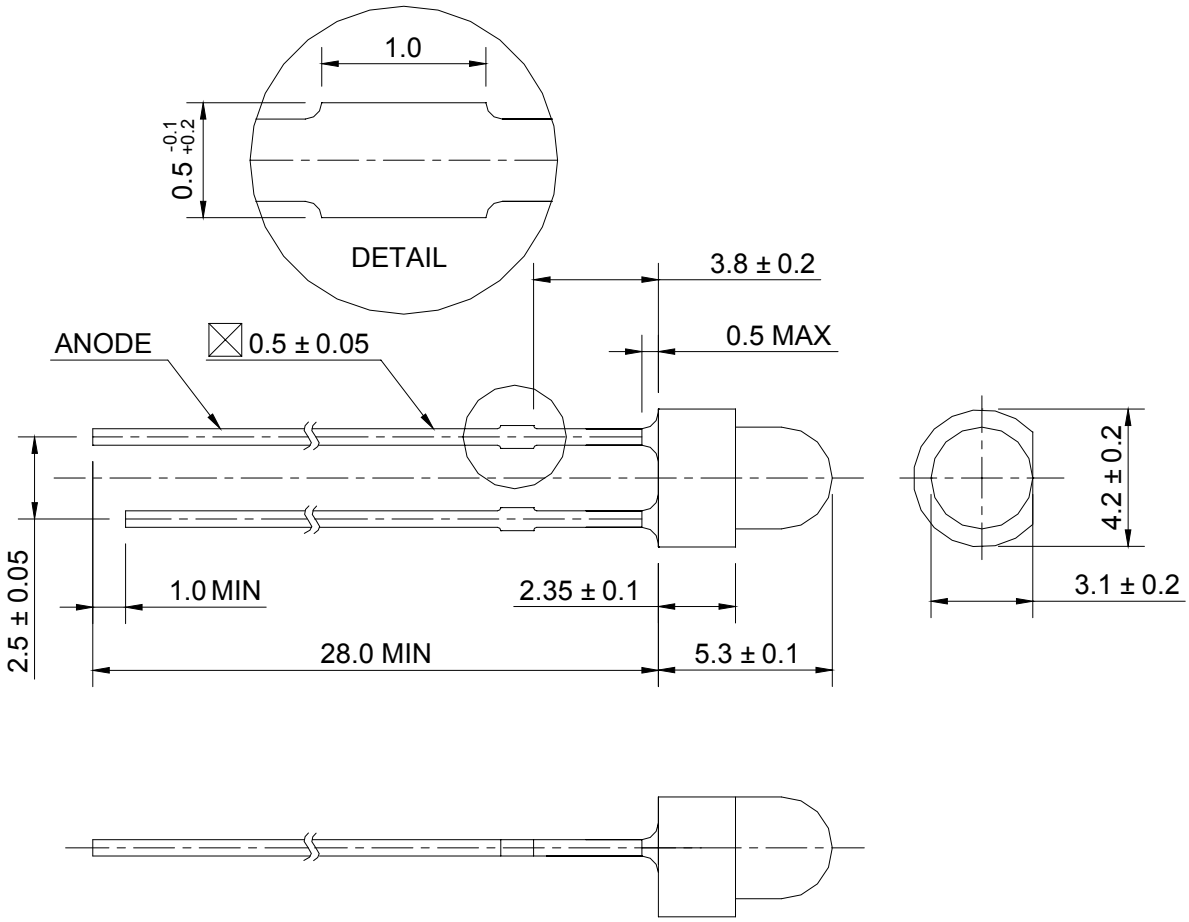
Dominant Wavelength (nm) @ I_F = 20mA		
Bin Code	Min.	Max.
-	625	670

Forward Voltage (V) @ I_F = 20mA		
Bin Code	Min.	Max.
-	1.7	2.3

☐ **Available ranks**

7. Outline Dimensions

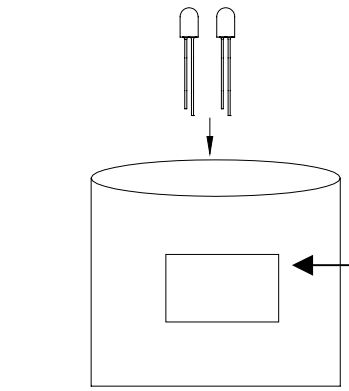
Unit : mm



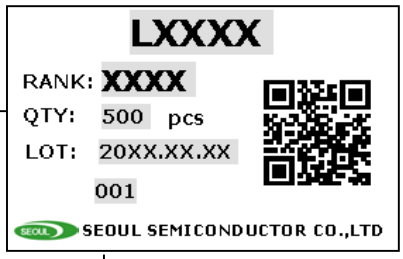
Notes : Protruded epoxy is 1.0mm maximum.

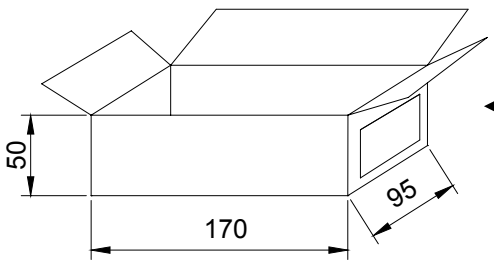
8. Packing

Unit : mm

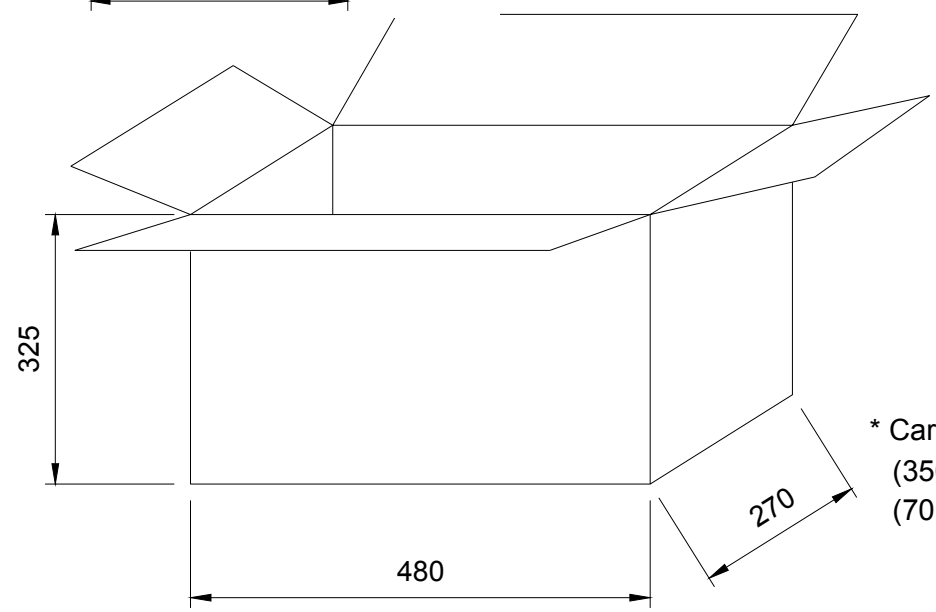


* Antistatic poly bag
(500pcs max/bag)





Inner box
(1bag max/box)

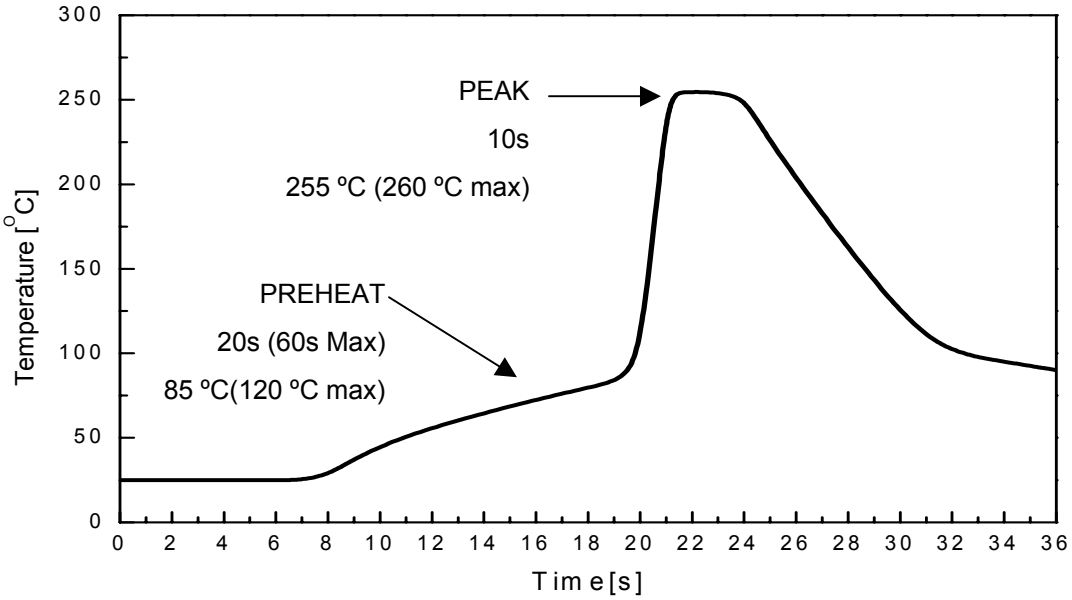


* Cardboard box
(35000pcs max/box)
(70boxes max/box)

9. Soldering Profile

1) Wave Soldering Conditions / Profile

- Preliminary heating to be at 85ºC(120 ºC max) for 20 seconds(60 seconds max).
- Soldering heat to be at 255 ºC (260ºC max) for 10 seconds
- Soak time above 200 ºC is 5 seconds



2) Hand Soldering conditions

- Not more than 3 seconds at max. 350ºC, under Soldering iron.

3) Caution

- Lead frames are silver plated copper alloy. This substance has a low thermal coefficient (easily conducts heat)
- The LEDs must not be repositioned after soldering.
- Do not apply any stress to the lead particularly when heat.

Note : In case the soldered products are reused in soldering process, we don't guarantee the products.

10. Precaution for Use

1) Storage

• Before opening the package

Avoid the absorption of moisture, we recommended to store Lamp LEDs in a dry box(or desiccators) with a desiccant . Otherwise, store them in the following environment:
Temperature : 5℃~30℃ Humidity : 50% max.

• After opening the package

a. Soldering should be done right after opening the package(within 24Hrs).

b. Keeping of a fraction

- Sealing
- Temperature : 5 ~ 40℃, Humidity : less than 30%

c. If the package has been opened more than 1week or the color of desiccant changes, Components should be dried for 10-12hr at 60±5℃

• Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temp. after soldering.

• Avoid quick cooling

• Leadframes are silver plated SPCC. The silver plate surface may be affected by environments which contains corrosive substances. Please avoid conditions which may cause the LEDs to corrode, tarnish or discolor.

2) Lead Forming

• When the lead forming is required before soldering , care must be taken to avoid any bending and mechanical stress. The stress to the base may damage the LEDs.

• When mounting the LEDs onto a PCB, the holes on the circuit board should be exactly aligned with the leads of the LEDs.

• It is recommended that tooling made to precisely form and cut the leads to length rather than rely on hand operating.

3) Static Electricity

- Static Electricity and surge voltage damage the LEDs. So it is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs.
- All devices, equipment and machinery must be properly grounded. It is recommended precautions be taken against surge voltage to the equipment that mounts the LEDs.

4) Heat Generation

- Thermal is one of the important parameter to design the end product. Please consider the heat generation of the LEDs.
- The operating current should be decided after considering the ambient maximum temperature of LEDs.

5) Others

- The color of the LEDs is changed a little by an operating current and thermal.
- Anti radioactive ray design is not considered for the products listed here in.
- Gallium arsenide is used in some of the products listed in this publication. These products are dangerous if they are burned or smashed in the process of disposal. It is also dangerous to drink the liquid or inhale the gas generated by such products when chemically disposed.
- This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When washing is required, IPA(Isopropyl Alcohol) should be used.
- When the LEDs are illuminating, operating current should be decided after considering the junction temperature.
  Cf.) Please refer *Ambient temperature vs. Forward Current* graph on page 5
- The appearance and specifications of the product may be modified for improvement without notice.

SEOUL SEMICONDUCTOR CO., LTD.
148-29, Kasan-Dong, Keumchun-Gu, Seoul, Korea
TEL : +82-2-3281-6269 FAX :+82-2-857-5430
www.seoulsemicon.com www.zled.com